

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
IPCB1	1		Printed Circuit Board		PMP9061	Any	-	-
C2	1	2200pF	CAP, CERM, 2200pF, 630V, +/-10%, X7R, 1206	1206	GRM31BR72J222KW01L	MuRata		
C3	1	1000uF	CAP ALUM 1000UF 25V 20% RADIAL	RCAP, 6.3x8mm	EEU-FC1E102L	Panasonic		
C5	1	0.47uF	CAP, Film, 0.47uF, 275V, +/-20%, TH	Radial 25x8.5x18.5	ECQ-U2A474ML	Panasonic		
C6	1	10uF	CAP, CERM, 10uF, 25V, +/-20%, X7R, 1210	1210	C3225X7R1E106M	TDK		
C7	1	0.1uF	CAP, CERM, 0.1uF, 25V, +/-10%, X7R, 0805	0805	08053C104KAT2A	AVX		
C8	1	10uF	CAP ALUM 10UF 400V 20% RADIAL	RCAP, 10x20mm	EEUEE2G100	Panasonic		
C9	1	22uF	CAP, AL, 22uF, 400V, +/-20%, 1.302176 ohm, TH	12.5x25	EEUED2G220	Panasonic		
C10	1	0.1uF	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	0603	06035C104KAT2A	AVX		
C11	1	22uF	CAP, AL, 22uF, 25V, +/-20%, TH	RCAP, 5x5mm	25ML22MEFC5X5	Rubycon		
D1	1	150V	DIODE SCHOTTKY 150V 1A DO214AC	SMA	SS1150-LTP	Micro Commercial Componen		
D2	1	1.7V	Diode, Ultrafast, 1000V, 1A, SMA	SMA	US1M-13-F	Diodes Inc.		
D3	1		DIODE SWITCH 200V 200MA SOD323	SOD-323	BAS20HT1G			
D4	1	1.15V	Diode, Switching-Bridge, 600V, 0.5A, MiniDIP	MiniDIP	RH06-T	Diodes Inc.		
L1, L3	2	2.2mH	Inductor, Drum Core, Ferrite, 2.2mH, 0.095A, 6.2 ohm, TH	Inductor, 7.87x9.271mm	RL-5480-2-2200	Renco Electronics		
L2, L4	2	470uH	Inductor, Drum Core, Ferrite, 470uH, 0.42A, 1.48 ohm, SMD	SDR1006	SDR1006-471KL	Bourns		
Line, Neutral, TP1, TP2	4		Header, TH, 100mil, 2x1, Gold plated, 230 mil above insulator	2x1 Header	TSW-102-07-G-S	Samtec		
R2, R5	2	6.8k	RES, 6.8k ohm, 5%, 0.25W, 1206	1206	CRCW12066K80JNEA	Vishay-Dale		
R3	1	120k	RES, 120k ohm, 5%, 0.25W, 1206	1206	CRCW1206120KJNEA	Vishay-Dale		
R4	1	5.1k	RES, 5.1k ohm, 5%, 0.125W, 0805	0805	CRCW08055K10JNEA	Vishay-Dale		
R6	1	51	RES, 51 ohm, 5%, 0.125W, 0805	0805	CRCW080551R0JNEA	Vishay-Dale		
R7	1	15.0	RES, 15.0 ohm, 1%, 0.1W, 0603	0603	CRCW060315R0FKEA	Vishay-Dale		
R8	1	76.8k	RES, 76.8k ohm, 1%, 0.25W, 1206	1206	CRCW120676K8FKEA	Vishay-Dale		
R9	1	1.3k	RES, 1.3k ohm, 5%, 0.1W, 0603	0603	CRCW06031K30JNEA	Vishay-Dale		
R10	1	24.3k	RES, 24.3k ohm, 1%, 0.1W, 0603	0603	CRCW060324K3FKEA	Vishay-Dale		
RV1	1		Varistor 275V RMS 10MM Radial, TH	10mm Radial	S10K275E2	EPCOS Inc		
T1	1	700 uH	Transformer, 1.59 mH		RLTI-1095	Renco		
U1	1		LOW STAND-BY POWER, CV / CC PWM HV SWITCHER WITH PRIMARY SIDE REGULATION, D0007A	D0007A	UCC28910D	Texas Instruments		None
C1	0	100pF	CAP, CERM, 100pF, 100V, +/-5%, COG/NP0, 0603	0603	C1608C0G2A101J	TDK		
C4	0	470uF	CAP, AL, 470uF, 6.3V, +/-20%, 0.008 ohm, TH	RCAP, 6.3x8mm	RS80J471MDN1JT	Nichicon		
R1	0	DNP	RES, 0 ohm, 5%, 0.125W, 0805	0805	CRCW08050000Z0EA	Vishay-Dale		

Notes:
Unless otherwise noted in the Alternate PartNumber and/or Alternate Manufacturer columns, all parts may be substituted with equivalents.

IMPORTANT NOTICE FOR TI REFERENCE DESIGNS

Texas Instruments Incorporated ("TI") reference designs are solely intended to assist designers ("Buyers") who are developing systems that incorporate TI semiconductor products (also referred to herein as "components"). Buyer understands and agrees that Buyer remains responsible for using its independent analysis, evaluation and judgment in designing Buyer's systems and products.

TI reference designs have been created using standard laboratory conditions and engineering practices. **TI has not conducted any testing other than that specifically described in the published documentation for a particular reference design.** TI may make corrections, enhancements, improvements and other changes to its reference designs.

Buyers are authorized to use TI reference designs with the TI component(s) identified in each particular reference design and to modify the reference design in the development of their end products. HOWEVER, NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY THIRD PARTY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT, IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI REFERENCE DESIGNS ARE PROVIDED "AS IS". TI MAKES NO WARRANTIES OR REPRESENTATIONS WITH REGARD TO THE REFERENCE DESIGNS OR USE OF THE REFERENCE DESIGNS, EXPRESS, IMPLIED OR STATUTORY, INCLUDING ACCURACY OR COMPLETENESS. TI DISCLAIMS ANY WARRANTY OF TITLE AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, QUIET ENJOYMENT, QUIET POSSESSION, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS WITH REGARD TO TI REFERENCE DESIGNS OR USE THEREOF. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY BUYERS AGAINST ANY THIRD PARTY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON A COMBINATION OF COMPONENTS PROVIDED IN A TI REFERENCE DESIGN. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, SPECIAL, INCIDENTAL, CONSEQUENTIAL OR INDIRECT DAMAGES, HOWEVER CAUSED, ON ANY THEORY OF LIABILITY AND WHETHER OR NOT TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES, ARISING IN ANY WAY OUT OF TI REFERENCE DESIGNS OR BUYER'S USE OF TI REFERENCE DESIGNS.

TI reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques for TI components are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

Reproduction of significant portions of TI information in TI data books, data sheets or reference designs is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards that anticipate dangerous failures, monitor failures and their consequences, lessen the likelihood of dangerous failures and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in Buyer's safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed an agreement specifically governing such use.

Only those TI components that TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components that have **not** been so designated is solely at Buyer's risk, and Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.